FDS6575

P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

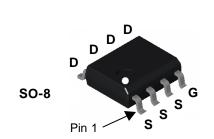
This PChannel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications wth a wide range of gate drive voltage (2.5V - 8V).

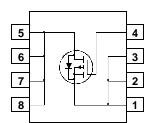
Applications

- Power management
- Load switch
- Battery protection

Features

- -10 A, -20 V. $R_{DS(ON)}$ = 13 m Ω @ V_{GS} = -4.5 V $R_{DS(ON)}$ = 17 m Ω @ V_{GS} = -2.5 V
- Low gate charge
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High current and power handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

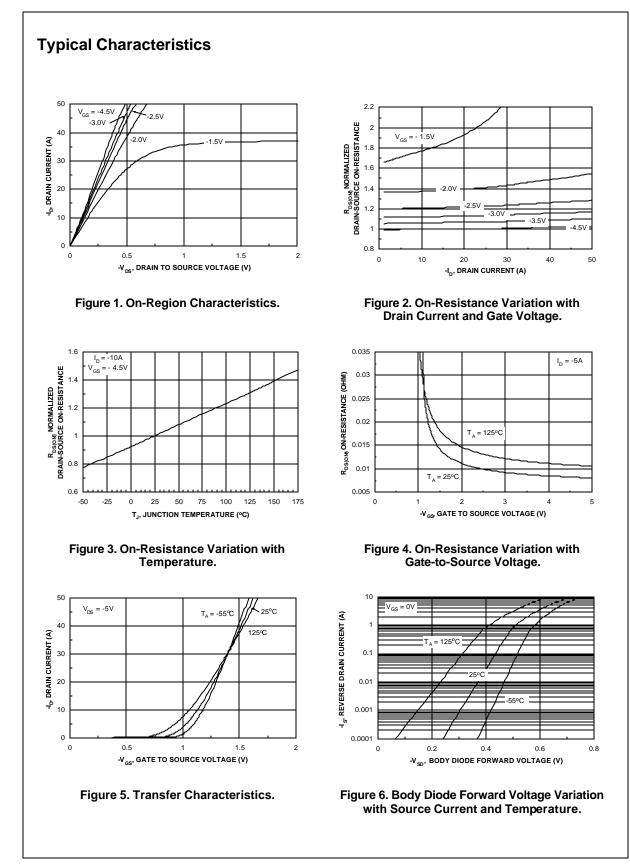
Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Sour	Drain-Source Voltage		-20	V	
V _{GSS}	Gate-Source	ce Voltage		±8	V	
l _D	Drain Curre	ent – Continuous	(Note 1a)	-10	A	
		– Pulsed		-50		
PD	Power Diss	ipation for Single Operation	(Note 1a)	2.5	W	
			(Note 1b)	1.5		
			(Note 1c)	1.2		
			(
T _J , T _{STG}	Operating a	and Storage Junction Temper	. ,	-55 to +175	°C	
Therma	l Charac	<u> </u>	ature Range	-55 to +175 50		
Therma R _{0JA}	I Charac	teristics	ature Range			
Therma R _{0JA} R _{0JA}	I Charac Thermal Re Thermal Re	teristics esistance, Junction-to-Ambier	ature Range	50	°C/W	
R _{0JA} R _{0JA} R _{0JC}	I Charac Thermal Re Thermal Re Thermal Re	teristics esistance, Junction-to-Ambier esistance, Junction-to-Ambier	ature Range	50 125	°C/W	
Therma R _{0JA} R _{0JA} R _{0JC} Packag	I Charac Thermal Re Thermal Re Thermal Re	teristics esistance, Junction-to-Ambier esistance, Junction-to-Ambier esistance, Junction-to-Case g and Ordering Inf	ature Range	50 125	°C/W	

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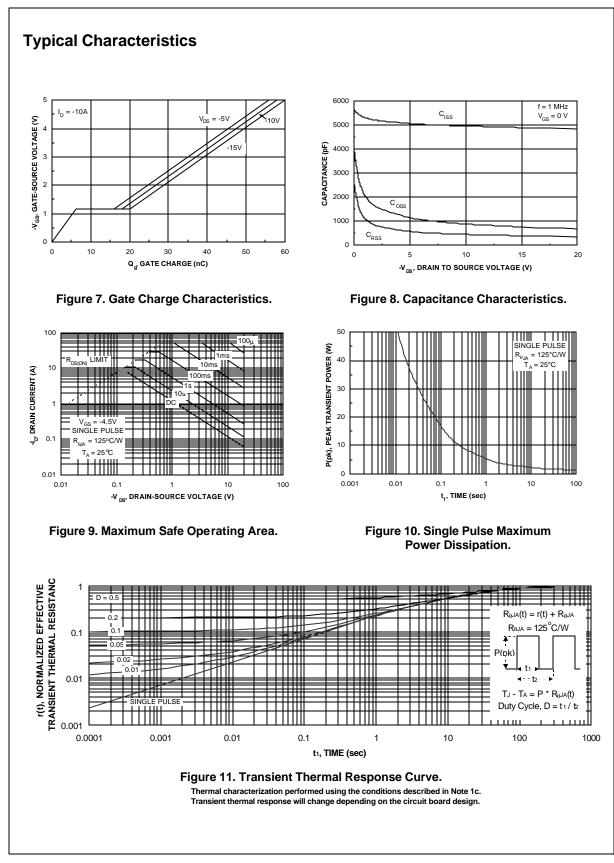
Off Char	Parameter	Test Conditions	Min	Тур	Max	Units
	acteristics	I				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-20			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-13		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μΑ
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-0.6	-1.5	V
$\Delta V_{GS(th)} \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V, \ \ l_{D} = -10 \ A \\ V_{GS} = -2.5 \ V, \ \ l_{D} = -9 \ A \\ V_{GS} = -4.5 \ V, \ \ \ l_{D} = -10A, \ T_{J} = 125^{\circ}C \end{array} $		8.5 11 11	13 17 20	mΩ
D(on)	On–State Drain Current	$V_{GS} = -4.5 V$, $V_{DS} = -5 V$	-50			Α
g fs	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -10 A$		57		S
Dvnamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		4951		pF
Coss	Output Capacitance	f = 1.0 MHz		884		, pF
Crss	Reverse Transfer Capacitance			451		pF
t _{d(on)}	g Characteristics (Note 2) Turn–On Delay Time	$V_{DD} = -10V, I_D = -1 A,$		16	29	ns
t _r	Turn-On Rise Time	$V_{GS} = -4.5 V, R_{GEN} = 6 \Omega$		9	18	ns
t _{d(off)}	Turn-Off Delay Time			196	314	ns
t _f	Turn-Off Fall Time	-		78	125	ns
Q _q	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -10 A$,		53	74	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		6	74	nC
Q _{gd}	Gate-Drain Charge	-		12		nC
0	Ũ			12		
	burce Diode Characteristics				0.4	•
s	Maximum Continuous Drain–Source Drain–Source Diode Forward				-2.1	A
V _{SD}	Voltage	$V_{GS} = 0 V$, $I_S = -2.1 A$ (Note 2)		-0.6	-1.2	V

FDS6575 Rev F(W)



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